

AN607

Power-up Trouble Shooting

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INTRODUCTION

For any application to begin proper operation, the application must power-up properly. Many criteria must be taken into account to ensure this. The PICmicro™ devices integrate several features to simplify the design for the power-up sequence. These integrated features also reduce the total system cost.

This application note describes the requirements for the device to properly power-up, common pitfalls that designers encounter, and methods to assist in solving power-up problems.

THE POWER-UP SEQUENCE

There are several factors that determine the actual power-up sequence that a device will go through. These factors are:

- The Processor Family
 - PIC16C5X (Baseline)
 - PIC16CXXX (Midrange)
 - PIC17CXXX (High-end)
- · Oscillator Configuration
- Device Configuration
- MCLR pin

Note: The PIC16CXXX family refers to devices with a 14-bit instruction word. This does not include the PIC16C5X family.

The Power-on Reset (POR) signal generation is discussed, followed by the power-up sequence for the specific device families.

Power-on Reset (POR) signal

The data sheets show a Power-on Reset (POR) pulse, as in Figure 1. The POR signal is a level triggered signal. This representation may help in the understanding of future devices, which may have a brown-out reset capability.

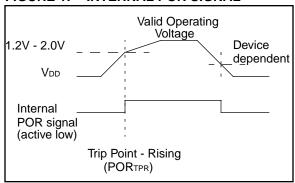
The power-up sequence begins by increasing the voltage on the V_{DD} pin (from 0V). If the slope of the V_{DD} rise time is faster than 0.05 V/ms, the internal circuitry is

capable of generating an internal reset signal. Depending on the device family, different power-up sequences will occur after this POR signal.

If the slope is less then 0.05 V/ms, the \overline{MCLR} pin should be held low, by external circuitry, until a valid operating V_{DD} level is reached.

The V_{DD} rise time specification needs to be met, until the POR signal is generated. After the POR signal is generated the slope of the V_{DD} rise can change (to a faster or slower rise). This may have other ramifications, see the "Power-up Consideration" section. In general, the POR signal will trip (POR_{TP}) somewhere between 1.2V to 2.0V (Figure 1).

FIGURE 1: INTERNAL POR SIGNAL



When V_{DD} is falling, the voltage at which the internal POR signal returns to a low level is processor/device dependent. To ensure that a device will have a POR, the device voltage must return to Vss before power is re-applied.

Note: Some devices (with EPROM program memory) have a newer POR circuit that does not require V_{DD} to return to Vss. See the device data sheet for the complete specification on the POR operation.

The POR will be generated regardless of the level of the $\overline{\text{MCLR}}$ pin. The PICmicro device families are different on what triggers the power-up sequence. Table 1 describes the events that cause the POR sequence to occur.

After reaching the POR trip point (PORTPR), the POR sequence holds the device in reset for a given time. Once this time has elapsed, the device voltage must be valid or the \overline{MCLR} pin must be low. The time from the POR rising edge to the time that VDD must be valid level is the TPOR2VDDV time.

TABLE 1: EVENTS THAT TRIGGER POR SEQUENCE

Device	Events			
PIC16C5X	Both the POR signal rising edge and			
	any MCLR rising edge ⁽¹⁾			
PIC16CXXX	The POR signal rising edge			
PIC17CXXX	Either the POR signal rising edge or the first MCLR rising edge (if MCLR is low when the POR occurs). After this event, all following MCLR rising edges ⁽¹⁾ cause the device to start program execution immediately.			

Note 1: The POR low-to-high transition onfigures Special Function Register (SFR) bits/registers to a specified value. The SFR bits/register are not identically affected by the MCLR signal. Refer to the device data sheet to see how the bits are affected by these two conditions.

The POR sequence for each of the PICmicro families is described in the following three sections:

PIC16C5X Family

PIC16CXXX Family

PIC17CXXX Family

PIC16C5X Family

After the MCLR pin has reached a high level, the device is held in reset for typically 18 ms. This time is determined by an on-chip RC oscillator and 8-bit ripple counter. This Device Reset Timer (DRT), allows most crystals (except low frequency crystals) to start-up and stabilize. Due to the characteristics of resistors and capacitors, this time is extremely variable over temperature and voltage. There is also a device to device variation. See the data sheet for the range of this time-out.

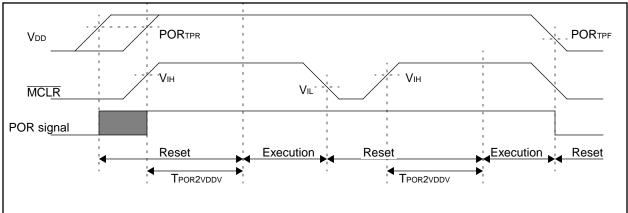
TABLE 2: TIME-OUT IN VARIOUS SITUATIONS (TYPICAL)

Oscillator Configuration	Power-up	Wake-up from SLEEP		
XT, HS, LP ⁽¹⁾	18 ms	18 ms		
RC	18 ms	18 ms		

Note 1: 32 kHz crystals have a typical start-up time of 1-2 seconds. Crystals >100 kHz have a typical start-up time of 10-20 ms.

Resonators are typically <1 ms. All these times are voltage dependent.

FIGURE 2: PIC16C5X POWER-UP SEQUENCE



PIC16CXXX Family

After the POR rising edge has occurred, the device can have up to 2 time-out sequences that occur in series. The first being the Power-up Timer (PWRT), the second being the Oscillator Start-up Timer (OST).

The Power-up Timer time-out will occur if enable bit PWRTE is read as a '1'. The PWRT uses a 10-bit counter, with the clock from an internal RC. Due to the characteristics of resistors and capacitors, this time is extremely variable over temperature and voltage. There is also a device to device variation. See the data sheet for the range of this time-out.

Note: Future devices will change the polarity of the PWRTE configuration bit. Refer to the specific data sheet for the polarity of this bit.

The OST will occur on power-up/wake-up when the device has oscillator mode selected. This allows the oscillator to stabilize before program execution begins. The OST uses a 10-bit counter, with the clock from the OSC pin. The time is dependent on the frequency of the input clock. This timer is disabled if the oscillator is configured as RC.

Figure 3 shows how the two timers work in the power-up sequence. V_{DD} must be valid when program execution starts. The $T_{PWRT} + T_{OST}$ times can be thought of as the time that the device gives for the V_{DD} to become valid ($T_{POR2VDDV}$). Figure 4 shows when device execution begins for the case of the \overline{MCLR} pin going high before $T_{POR2VDDV}$ times out. Figure 5 shows when the \overline{MCLR} pin is held low longer than the $\overline{T_{POR2VDDV}}$ time. The device starts execution immediately when \overline{MCLR} goes high. Table 3 gives typical reset times.

TABLE 3: TIME-OUT IN VARIOUS SITUATIONS (TYPICAL)

Oscillator	Powe	Wake-up	
Configuration	PWRTE = 1 (2)	PWRTE = 0 (2)	from SLEEP
XT, HS, LP ⁽¹⁾	72 ms + 1024 Tosc	1024 Tosc	1024 Tosc
RC	72 ms	_	_

Note 1: 32 kHz crystals have a typical start-up time of 1-2 seconds. Crystals >100 kHz have a typical start-up time of 10-20 ms. Resonators are typically <1 ms. All these times are voltage dependent.

2: Future devices will change the polarity of this configuration bit. Refer to the specific data sheet for the polarity of the PWRT Configuration Bit.

FIGURE 3: PIC16CXX POWER-UP SEQUENCE

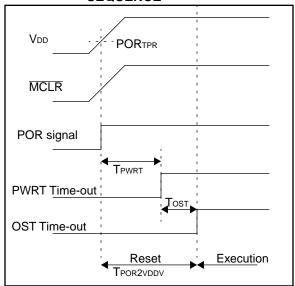


FIGURE 4: START OF DEVICE OPERATION (MCLR < TPOR2VDDV)

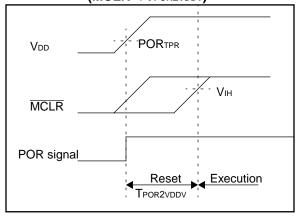
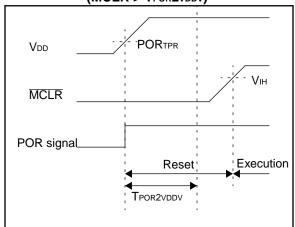


FIGURE 5: START OF DEVICE OPERATION (MCLR > TPOR2VDDV)



PIC17CXXX Family

When the \overline{MCLR} pin comes to a high level, after the POR rising edge, the device has 2 time-out sequences that occur in parallel. One is the Power-up Timer (PWRT), the other is the Oscillator Start-up Timer (OST). The timer with the greater time holds the device in reset. Figure 6 shows the sequence with \overline{MCLR} tied to VDD. Figure 7 show the time-out when \overline{MCLR} is independent of VDD. The PWRT time is generally longer, except for low frequency crystals/resonators. The OST time does not include the start-up time of the oscillator/resonator.

The PWRT uses a 10-bit counter, with the clock from an internal RC. The characteristics of the RC vary from device to device and over temperature and voltage. The specification for the time-out range can be found in the electrical specification of the data sheet.

The OST uses a 10-bit counter, with the clock from the OSC pin. The time is dependent on the frequency of the input clock.

Until MCLR has reached a high level, the POR sequence will not start. While the POR signal remains high, all following MCLR pulses will not cause the POR sequences to occur (Figure 8).

TABLE 4: TIME-OUT IN VARIOUS SITUATIONS (TYPICAL)

Oscillator Configuration	Power-up	Wake-up from Sleep	
RC, EC	Greater of 80 ms and 1024 Tosc	_	
XT, LF ⁽¹⁾	Greater of 80 ms and 1024 Tosc	1024 Tosc	

Note 1: 32 kHz crystals have a typical start-up time of 1-2 seconds. Crystals >100 kHz have a typical start-up time of 10-20 ms.

Resonators are typically <1 ms. All these times are voltage dependent.

FIGURE 6: PIC17CXX POWER-UP SEQUENCE (MCLR TIED TO VDD)

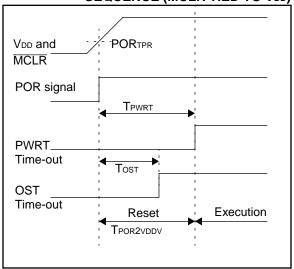


FIGURE 7: PIC17CXX POWER-UP SEQUENCE (MCLR NOT TIED TO VDD)

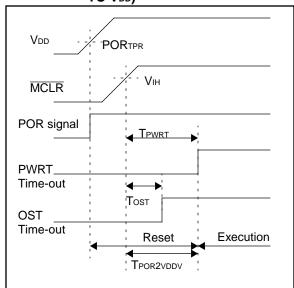
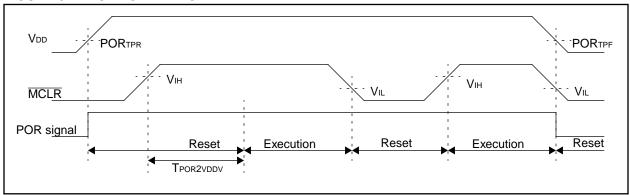


FIGURE 8: MCLR OPERATION



POWER-UP CONSIDERATIONS

The device must be at a valid operating voltage when the device exits reset. This can be done by ensuring that the power supply rise time is fast enough to guarantee an operating V_{DD} level, or by using an external reset circuit which will hold \overline{MCLR} low until the operating V_{DD} level is reached.

When the rise time of V_{DD} is very fast, there will be a time delay before the Power-on Reset (POR) signal will rise to a logic high ($T_{TP}2_{POR}H$). This delay is in the 1-5 μ s range, as shown in Figure 9.

Figure 10, Figure 11, and Figure 12 show the maximum time from the POR sequence beginning to the device having a valid operating voltage. Table 5 gives the TPOR2VDDV times. When determining the time at which VDD must be valid, the POR trip point must be assumed to be at the minimum POR voltage trip point.

How Crystal Frequencies affect Start-up time

Both the PIC16CXXX and PIC17CXXX families may have start-up times that include the contributions of the oscillator. Table 5 shows how the oscillator can affect each mode of operation, with Table 6 giving the reset time that an oscillator generates. This time can be used in the equation to calculate the total reset time, at the given frequency. This time may vary slightly due to the initial start-up characteristics of the crystal/oscillator circuit.

Note 1: The rise time specification does not ensure that a valid VDD operating voltage will be reached before the device exits reset. The device's VDD must be within the specified operating range for proper device operation.

Note 2: The start-up characteristics of the crystal/oscillator must also be taken into account when determining the time that the device must be held in reset.

TABLE 5: MAXIMUM TIME FROM POR RISING EDGE TO VALID VDD VOLTAGE

	Osc Mode	Maximum Time	Conditions
PIC16C5X	LP, XT, HS, and RC	9 ms	
×	RC	28 ms	
PIC16CXXX	LP, XT, and HS	28 ms + 1024 Tosc	PWRTE = 1
PIC1	LP, XT, and HS	1024 Tosc	PWRTE = 0
PIC17CXXX	LF, XT, EC, and RC	Greater of (40 ms or 1024 Tosc)	

FIGURE 9: POR DELAY FOR FAST VDD RISE TIME

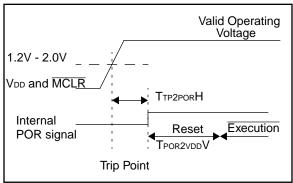


TABLE 6: RESETTIME DUE TO OSCILLATOR

	Clock Frequency								
	32 kHz	1 MHz	2 MHz	4 MHz	8 MHz	10 MHz	16 MHz	20 MHz	25 MHz
1024 Tosc	32 ms	1.0 ms	512 μs	256 μs	128 µs	102.4 μs	64 μs	51.2 μs	41 μs

FIGURE 10: MAXIMUM POWER-UP TIME, MCLR TIED TO VDD (PIC16C5X, PIC16CXXX, PIC17CXXX)

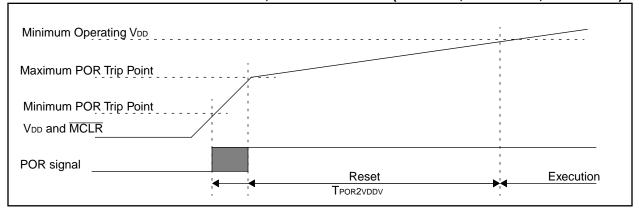


FIGURE 11: MAXIMUM POWER-UP TIME, MCLR NOT TIED TO VDD (PIC16CXXX)

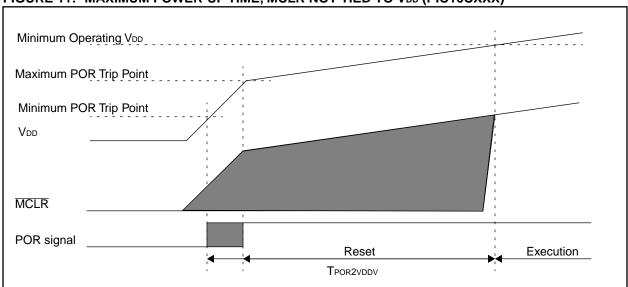
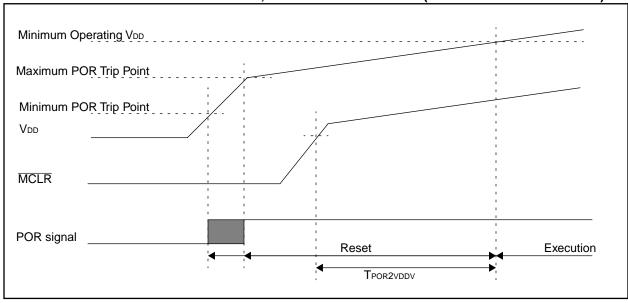


FIGURE 12: MAXIMUM POWER-UP TIME, MCLR NOT TIED TO VDD (PIC16C5X AND PIC17CXXX)



Oscillator and Resonator Considerations

Oscillators and resonators from different manufacturers may have different characteristics. The recommended capacitor selection can be found in each device's data sheet. When we do the capacitor selection, during the oscillator/resonator characterization, we are currently using devices from one of several manufacturers. Generally we use oscillators from either ECS, CTS, FOX or Epson, and ceramic resonators from either Murata Erie or Panasonic. Other manufacturers may be used in the future, depending on availability and other factors.

Other manufacturers devices may have significantly different characteristics. To ensure proper oscillator operation, the circuit should be verified at the lowest temperature/highest V_{DD} (to ensure that the crystal is not overdriven), and with the highest temperature/lowest V_{DD} (to ensure the device still starts up) that the device will be subjected to while in the application. This ensures a stable start-up and frequency for this device, at the extreme conditions of the application.

For production purposes, the above testing should be done with many different samples of the components selected. This is so the part to part variation of the capacitors, resistors, crystals/resonators, and PICmicro devices are taken into account. All PICmicro final data sheets supply the characterization information on the transconductance of the oscillator (measurement of gain). This information can be used to check part to part variations of the PICmicro.

When selecting the crystal, the designer must ensure that it is a parallel cut type. Failure to use a parallel cut crystal may cause:

- Frequency operation out of the specified range of the crystal.
- Unreliable oscillator start-up.
- Device or crystal damage.

RAM and Special Function Register Initialization

After a successful Power-up Reset, the device will begin to execute the firmware program. To have expected operation, ALL RAM should be initialized by the program. This includes the Special Function Registers (SFR) and the general purpose data memory. The use (read) of an uninitialized RAM location will cause the program to do exactly what you told it, with the unexpected RAM value. It should not be expected that all devices will power-up with the same uninitialized device values.

There are many factors that contribute to how a RAM cell powers up, but the most common "gotcha" is between the Windowed and OTP device types. Many times a user forgets to cover the window after erasing the Windowed device. When the device is powering up, and the light is able to shine onto the device die, the transistor characteristics will shift. This can cause the

device RAM to have a different power-up value than a device where no light can shine onto the die (OTP or covered).

Note:

RAM locations should be initialized before they are used. Use of an uninitialized location will cause proper device operation with the improper values. That is, it will do what you told it to do, not what you wanted it to do.

Valid Operating Voltage Levels

When the device is operating, the device voltage must be within the specified Min/Max limits. Operation of the device outside these limits may cause unexpected device operation.

One of the primary functional failure modes of a device is when the applied voltage is lower than the specified minimum requirement. This functional failure is called Brown-out. Brown-out causes the program memory not to be read correctly. For example, the program counter may be pointing to a MOVE instruction, but the device reads it as a GOTO instruction (with a random destination). This can have disastrous affects to the operation of the application. If brown-out conditions are possible, the application needs to be protected by using a brown-out circuit. A brown-out circuit works with the $\overline{\rm MCLR}$ pin to put the device in RESET before the device's actual voltage violates the minimum limit.

Figure 13 shows a low cost external brown-out protection circuit. The voltage at which the circuit causes a reset is dependent upon the tolerances of the components. Figure 14 shows the use of a Dallas Semiconductor EconoReset. This device monitors the status of the power supply, and generates a reset when an out-of-tolerance condition is detected. Motorola also makes some 3-terminal devices to monitor the power supply, such as the MC34164, MC34064, MC33064. Their data sheets should be reviewed to ensure that the device is suitable for your application.

FIGURE 13: LOW COST EXTERNAL BROWN-OUT PROTECTION CIRCUIT

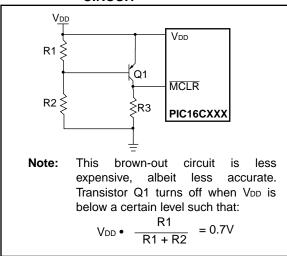
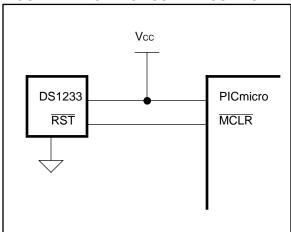


FIGURE 14: VOLTAGE SUPERVISORY CHIP



Brown-out and the WDT

The recommended solution for brown-out conditions is the use of a brown-out circuit. The brown-out circuit will keep the device in reset until a valid operating voltage is present. In some applications the additional cost of the external brown-out circuit, can be traded-off with system recovery from brown-out. Use of the Watchdog Timer (WDT) can enhance the probability of system recovery from a brown-out condition.

Note: If I/O drive conflicts can cause critical problems, this technique should not be used. This is due to the indeterminate time before a device reset could occur, which would reset all pins to inputs to eliminate any I/O conflict.

When using the WDT in brown-out conditions, care must be taken. Brown-outs may cause an unrecoverable condition, but with good design practice the probability of this can be significantly reduced.

During a brown-out, improper program execution can occur due to an EPROM read failure. This program execution can also corrupt data memory locations, which include the Special Function Registers (SFRs). Corrupting the control registers may cause hardware conflicts. For example, an input may become an output. Other conflicts are possible, but the situation will be application dependent.

As the device voltage gets lower, internal logic can become corrupted. This can include the Program Counter (PC) value, Stack Pointer and contents, State machines, Data Memory, etc.

When a valid voltage is returned, the device may be at an unexpected program location, possibly using corrupted values. In this situation, the device would not be expected to operate as intended and could get into a state that appears locked-up.

For the PIC17C42 in code protected microcontroller mode, once the Program Counter (PC) exceeds the 32K-word boundary, the device will become locked-up. The PC can exceed the 32K-word boundary from the execution of incorrect instructions (due to failure reading the EPROM) or by the PC becoming corrupted.

If the WDT is to be used to reset the device, care must be used in structuring the program. Optimally, only one CLRWDT instruction should be used. This minimizes the possibility of program execution returning to a loop which clears the WDT. This loop could then lock-up the device, since other control registers are corrupted and the device is not configured as expected. An example is; if the loop was waiting for an interrupt, but the bit that enables global interrupts was disabled, the device would no longer respond to the interrupts and would appear locked-up.

Example 1 shows a simple implementation of using the WDT reset for system recovery. The program loops, waiting for a WDT time-out (which clears the $\overline{10}$ bit). After the WDT reset, the $\overline{10}$ bit needs to be set (by executing a CLRWDT instruction). The program should then initialize the device. Then application code can start executing. There is a possibility of the $\overline{10}$ bit being corrupted by low voltage, and the device not being in a reset state when the software initializes the device.

The WDT example in Appendix B: uses a different method, independent of the $\overline{\text{TO}}$ bit. This uses RAM locations which get loaded with a value. A WDT time-out (or other reset) needs to occur. The RAM locations are verified to contain the same values. Once the RAM is verified, it is cleared, and the device should be initialized. These RAM locations can be used by the application program.

EXAMPLE 1: USING WDT RESET

org	Reset_A	Reset_Address				
	GOTO	TO_TEST	;At any reset, ;test the $\overline{\text{TO}}$ bit			
org	TO_TEST	ľ				
	BTFSC	STATUS, TO	;WDT Time-Out?			
HERE	GOTO	HERE	;NO, Wait for $\overline{ ext{TO}}$			
Time_Ou	ıt		;YES, Good Reset			
	CLRWDT		;Start here			
	:		;Initialize Device			
	:		;Application Code			

False Power-down

In applications where power is removed from the device's supply lines, but voltage is still applied to an I/O pin, unexpected operation may occur. Power is able to be supplied to the device through this I/O pin. Since the device is still partially powered, the internal logic is never completely powered down. Figure 15 shows the general structure of an I/O pin. Figure 16 depicts the internal voltage level that is actually applied to some device logic, versus what is seen at the pin.

To guarantee a Power-on Reset (POR) rising edge, the device voltage (VDD) must start from Vss. When the device is inadvertently powered from an I/O pin, the voltage at the VDD pin may appear to be near ground but may actually be higher in the device. With some of the internal logic powered, the characteristics of the device can be similar to a brown-out situation. Similar design practices to brown-out should be implemented.

A method for protecting the device from being powered from an I/O pin is shown in Figure 17.

FIGURE 15: TYPICAL ELECTRICAL STRUCTURE OF I/O PIN

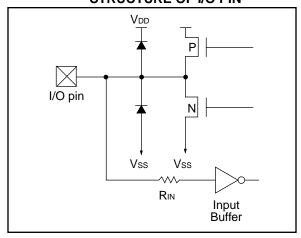


FIGURE 16: FALSE POWER-DOWN

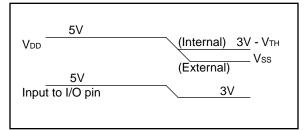
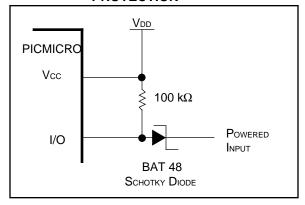


FIGURE 17: POWERED INPUT PROTECTION



In general, a brown-out detect circuit should cause the PICmicro to RESET (\overline{MCLR} forced low). This ensures that the internal logic is in a known state until a valid device voltage level is reached. The actual brown-out circuit depends on the voltage range of the device and the application requirements. A comprehensive brown-out circuit would use a dedicated device to monitor the voltage and force the \overline{MCLR} pin low when the voltage becomes lower than specified.

Another case of false power-down situations is when the power is removed from the system, but the capacitor loading keeps a non-zero voltage on the V_{DD} pin. When power is reapplied, the device never powered down so no Power-on-Reset will occur. A simple brown-out circuit should fix this.

TROUBLESHOOTING

There are several techniques that can be used to troubleshoot problems related to powering up. First it is important to try to locate the source of the problem. These sources could be:

- No oscillation on OSC1/OSC2 pins
- Improper/no Program Execution

In cases where there is no oscillation on the OSC1/OSC2 pins, some of the following should be tried:

- a) Verify that there are good connections/the components are good.
- b) Verify that the crystal/resonator manufacturer is one that has been tested, if not try other capacitor values.
- See if an external clock (from a function generator) causes device operation to begin.
- d) Verify that all components are well grounded.
- e) If a scope probe is connected to the oscillator output, it must be a low capacitance/high impedance probe. If it is not, the oscillator may stop.

In cases where program execution is not as expected:

- a) Use a minimal program with external clock input.
- b) Tie MCLR to ground until solid power is applied to the device then release MCLR (bring high).
- c) Measure V_{DD} rise time to determine if an external reset circuit is needed, and, if so, what type of reset circuit should be used.
- Verify that the device program memory and configuration bits are programmed to their expected states.

The flowchart shown in Figure 18 can be used to troubleshoot power-up problems. This flowchart is only intended to be the first level diagnostic in trying to solve a power-up problem. Many other flowcharts can be used, depending on the characteristics of the problem and the set-up of the application.

CONCLUSION

Understanding the criteria for the powering up of a device will allow you to make better design choices. If device power-up problems are still encountered, many techniques can be used to solve the problem. Appendix B contains example code which can be used to verify that a device is operating (powered-up correctly). This eliminates the possibility of the program as the cause, and allows debug on the hardware.

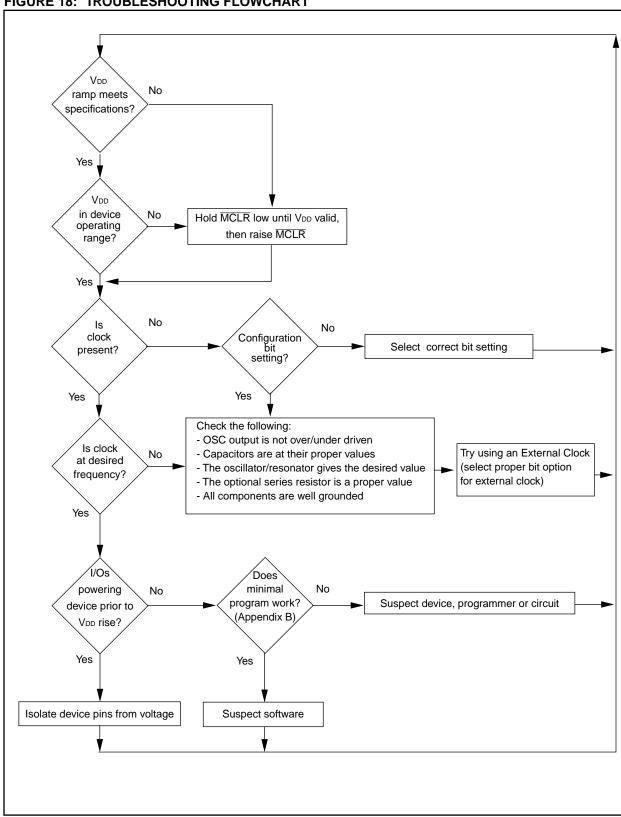


FIGURE 18: TROUBLESHOOTING FLOWCHART

APPENDIX A: Q & As

- Q. When I use a windowed device (JW), my application works as expected. When I program an OTP device, it no longer works as expected. Why is this?
- A. The silicon is the same between the OTP and windowed devices. If the windowed device's window is not covered (with black tape), light shines onto the silicon. The light causes the potential levels of gates to shift. This in turn can cause RAM to be initialized to an unknown state, which could be different than in the OTP device. If RAM is not initialized by the program before it is used, these different power-up states of the RAM could be the cause of the problem. Ensure that all RAM is initialized in the device. This includes the SFRs.

Q. My oscillator is not oscillating, what could be wrong?

- A. There are several possibilities, some which include:
 - The wrong oscillator bit setting is selected. The erased (default) state is RC oscillator mode.
 - The wrong capacitor values are installed. Refer to the most current data sheet for recommended values.
 - The characteristics of your manufacturers crystal are different than those that are characterized by Microchip. Generally our tests have been done with one of the following manufacturers' crystals/ resonators: ECS, FOX, Murata Erie, or Panasonic.
 - The external connections to the device are wrong. Verify that all connections to the device are correct and that good signals / levels are being applied.
 - 5. The cut of the crystal is a series type, as opposed to the specified parallel type.
 - 6. No bypassing capacitors were used on the device. The noise on VDD could be affecting the oscillator circuitry.

Q. The device was powered-down and then powered back up, but the device does not operate. What could be wrong.

- A. Possibilities include:
 - If power was applied to an I/O pin when the device was "powered-down", the device would be powered through the I/O pin. The internal logic is not actually powered-down, and Power-on Reset (POR) will not occur.
 - 2. When V_{DD} was powered-down, V_{DD} was not given enough time to settle to 0V.
 - 3. The VDD ramp rate is too slow.

Q. My oscillator is oscillating, but the device is not working. What could be wrong?

- A. There are several possibilities, some which include:
 - Slow V_{DD} rise time, which was too slow to cause a Power-on Reset (POR). The rise time should not exceed the minimum device specification. For most devices this is 0.05 V/ms. Also the device must be at the minimum operating V_{DD} of the processor when reset is exited.
 - Ensure that the MCLR pin is not low. This holds the device in RESET.
 - A brown-out has occurred, and has corrupted the internal state machines (including the WDT). An external brown-out circuit is recommended to hold the device in RESET during the brown-out condition.
 - The CLRWDT instruction is not being used (often enough) when the WDT is enabled.

Q. When I power-up the device, it does not operate and it gets hot.

A. Your design is probably permitting fast high voltage signals (spike) onto one of the device pins. This sudden high voltage (and associated current) is in excess of the protection diode limit. The device must be powered-down (to Vss) to release this condition. This condition may cause a functional failure or affect device reliability. All Microchip devices meet or exceed the Human Body Model (HBM) and Machine Model (MM) for ESD and latch-up.

- Q. My oscillator is oscillating, but not at the expected frequency. What could be wrong.
- A. For many designers, working with oscillators and their related issues are a "black magic", since the characteristics can vary widely between manufacturers. I suggest that you read all the application notes that we have available on oscillators. Some quick possibilities are:
 - 1. The cut of the crystal is a series type, as opposed to the specified parallel type.
 - No bypassing capacitors were used on the device. The noise on V_{DD} could affect the oscillator circuitry.
 - The capacitor values used are causing the oscillator to operate in one of the harmonic frequencies.

Note: This is not an all inclusive list. You may need to investigate other design aspects.

- Q. The device seems to never exit reset, or is continually resetting.
- A. The CLRWDT instruction is not being used (often enough) when the WDT is enabled.
- Q. The device was powered-down and back up again, but it does not reset. It just starts operating immediately.
- A. Possibilities include:
 - If power was applied to an I/O pin when the device was "powered-down", the device would be powered through the I/O pin. The internal logic is not actually powered-down, and a Power-on Reset (POR) will not occur.
 - 2. When V_{DD} was powered down, V_{DD} was not given enough time to settle to 0V.
- Q. The oscillator is operating (I check it with a scope), yet when I look at other pins the program is not executing. Why?
- A. One possible reason is that when the oscilloscope probe is placed on the OSC2 pin, the additional capacitance is enough to cause oscillation to start. Removing the capacitive load of the probe causes the oscillation to stop.

Please check the Microchip BBS for the latest version of the source code. Microchip's Worldwide Web Address: www.microchip.com; Bulletin Board Support: MCHIPBBS using CompuServe[®] (CompuServe membership not required).

APPENDIX B: TEST PROGRAMS

PIC16C5X BIT TOGGLE

```
PAGE 1
MPASM 01.02.04 Intermediate C5X_B0T.ASM 12-20-1994 9:25:7
LOC OBJECT CODE
                  LINE SOURCE TEXT
 VALUE
                   0001
                                      P = 16C54, F = INHX8M, n = 66
                               LIST
                   0002;
                   0003 ; * *
                   0004 ;
                   0005 ; This program is a minimum program to toggle a single I/O port pin for the
                   0006; 16C5x family of devices. The only initialization is that of the data 0007; direction register (TRIS) of the I/O pin and the Toggling of the pin.
                   \ensuremath{\text{0008}} ; The waveform will be 1 unit high and 3 units low.
                   0009;
                   0010 ;
                                              C5X BOT.ASM
                               Program:
                              Revision Date: 12-20-94
                   0011;
                   0012 ;
                   0014;
                   0015 ;
                   0016 ; HARDWARE SETUP
                   0017;
                              None
                   0018;
                   0019 ;
                   0020
                                  INCLUDE <p16C5x.inc>
                   0002 ; P16C5X.INC Standard Header File, Version 0.1 Microchip Technology, Inc.
                   0020
                   0021 ;
 0FF9
                   0022
                               __FUSES ( _CP_OFF & _WDT_OFF & _XT_OSC )
                   0023 ;
                   0025 ;****
                                 Start program here.
                   0027;
0000
                   0028 START
                                                        ; POWER_ON Reset (Beginning of program)
0000 0063
                   0029
                                  CLRF
                                         STATUS
                                                        ; Do initialization (Bank 0)
0001 0C00
                   0030
                                  MOVLW
                                         0x00
                                                        ; Specify value for PortB output latch
0002 0026
                   0031
                                  MOVWF
                                         PORTB
0003 0C00
                   0032
                                  MOVLW
                                         0x00
                                                        ; Specify which PortB pins are inputs / outputs
0004 0006
                                         PORTB
                   0033
                                  TRIS
                   0034 ;
0005 0506
                   0035 lzz
                                  BSF
                                         PORTB, 0
                                                        ; BO is High
                                  BCF
                                         PORTB. 0
                                                        ; B0 is Low
0006 0406
                   0036
0007 0A05
                   0037
                                  GOTO
                                         lzz
                                                        ; Loop
                   0038;
                   0039;
                   0040
                   0041 ;
                   0042; Reset address. Determine type of RESET
                   0043;
                   0044
                           IFDEF
                                    _16C54
 01FF
                   0045 RESET_V
                                  EOU
                                         0x1FF
                   0046
                           ENDIF
                   0047 ;
                   0048
                           IFDEF
                                    _16C54A
                   0049 RESET_V
                                  EOU
                                         0x1FF
                   0050
                           ENDIF
                   0051;
                   0052
                           IFDEF
                                    _16C55
                   0053 RESET_V
                                         0x1FF
                   0054
                           ENDIF
                   0055 ;
                   0056
                           IFDEF
                                    _16C56
                   0057 RESET_V
                                         0x3FF
                   0058
                           ENDIF
                   0059;
                                        _16C57
                   0060
                           IFDEF
                                             0x7FF
                   0061 RESET_V
                   0062
                           ENDIF
```

```
0063;
                      0064
                                IFDEF
                                              _16C58A
                      0065 RESET_V
                                             EQU 0x7FF
                                ENDIF
                      0066
                      0067;
                      0068 PROG_MEM_END
  01FE
                                            EQU RESET_V - 1
                      0069 ;
                      0070 ;
                                                                  ; End of Program Memory
; If you get here your program was lost
                      \begin{array}{ccccc} \texttt{0071} & & \texttt{org} & & \texttt{PROG\_MEM\_END} \\ \texttt{0072} & \texttt{ERR\_LP\_1} & & \texttt{GOTO} & & \texttt{ERR\_LP\_1} \end{array}
                      0071
                                            PROG_MEM_END
01FE OBFE
                      0073;
                                          RESET_V
                      0074 org RESET_V
0075 R_VECTOR GOTO START
                                                                  ; RESET vector location
01FF 0A00
                      0076 ;
                      0077 ;
                      0078
                                end
                      0079
                      0800
                      0081
MEMORY USAGE MAP ('X' = Used, '-' = Unused)
0000 : XXXXXXXX------
01C0 : ------XX
All other memory blocks unused.
Errors :
Warnings :
              0
Messages :
```

PIC16CXXX BIT TOGGLE

```
MPASM 01.02.04 Intermediate CXX_BOT.ASM 12-20-1994 10:18:22
                                                                   PAGE 1
LOC OBJECT CODE
               LINE SOURCE TEXT
 VALUE
                 0001
                           LIST P = 16C74, F = INHX8M, n = 66
                 0005; This program is a minimum program to toggle a single I/O port pin for the
                 0006 ; 16Cxx family of devices. The only initialization is that of the data
                 0007; direction register (TRIS) of the I/O pin and the Toggling of the pin.
                 0008; The waveform will be 1 unit high and 3 units low.
                 0009;
                 0010 ;
                                          CXX_BOT.ASM
                            Program:
                 0011;
                            Revision Date: 12-20-94
                 0012 ;
                 0014 ;
                 0015 ;
                 0016 ; HARDWARE SETUP
                 0017 ;
                           None
                 0018;
                 0019;
                 0020
                              INCLUDE <pl6Cxx.inc>
                 0002 ; P16CXX.INC Standard Header File, Version 0.2 Microchip Technology, Inc.
                 0020
                 0021;
 3FF9
                 0022
                            __FUSES ( _CP_OFF & _WDT_OFF & _XT_OSC & _PWRTE_ON )
                 0023;
                 0025 ;****
                             Start program here.
                 0027;
0000
                 0028 START
                                                   ; POWER_ON Reset (Beginning of program)
0000 0183
                                                   ; Do initialization (Bank 0)
                 0029
                               CLRF
                                      STATUS
0001 3000
                 0030
                               MOVLW
                                                   ; Specify value for PortB output latch
0002 0086
                               MOVWF PORTB
                 0031
0003 1683
                 0032
                               BSF
                                      STATUS, RPO
                                                   ; Bank 1
0004 3000
                 0033
                               MOVLW
                                      0x00
                                                   ; Specify which PortB pins are inputs / outputs
0005 0086
                 0034
                               MOVWF TRISB
0006 1283
                 0035
                                      STATUS, RPO
                               BCF
                                                   ; Bank 0
                 0036;
0007 1406
                 0037 lzz
                               BSF
                                      PORTB, 0
                                                   ; BO is High
                                                   ; B0 is Low
                                      PORTB, 0
0008 1006
                 0038
                               BCF
0009 2807
                 0039
                               GOTO
                                      lzz
                                                   ; Loop
                 0040;
                 0041;
                 0042
                 0043 ;
                 0044 ; End of Program Memory
                 0045 ;
                        TFDEF
                 0046
                                __16C71
                 0047 PROG_MEM_END EQU
                                         0x3FF
                 0048
                         ENDIF
                 0049;
                 0050
                         IFDEF
                               __16C71A
                 0051 PROG_MEM_END EQU
                                         0x3FF
                 0052
                         ENDIF
                 0053;
                 0054
                        IFDEF
                               __16C73
                 0055 PROG_MEM_END EQU
                                         0xFFF
                 0056
                         ENDIF
                 0057;
                               __16C74
                 0058
                         IFDEF
 0FFF
                 0059 PROG_MEM_END EQU
                                         0xFFF
                 0060
                         ENDIF
                 0061;
                 1FDEF __16C61
0063 PROG_MEM_END EOU
0064
                                         0x3FF
                 0064
                         ENDIF
                 0065;
                               __16C63
                 0066
                         IFDEF
                 0067 PROG_MEM_END
                                         0x7FF
                                 EOU
                 0068
                         ENDIF
                 0069;
                 0070
                         IFDEF __16C64
```

```
0071 PROG_MEM_END
                                     EQU
                                             0x7FF
                   0072
                           ENDIF
                   0073;
                   1FDEF __16C65
0075 PROG_MEM_END EOU
0076 ____
                                             0xFFF
                           ENDIF
                   0077 ;
                   1FDEF __16C84
0079 PROG_MEM_END EOU
0080
                                             0x3FF
                   0081;
                   1FDEF __16C84A
0083 PROG_MEM_END FOUT
0084 FOUT
                                             0x3FF
                   0084
                   0085;
                   0086;
                              org PROG_MEM_END
                   0087
                                                        ; End of Program Memory
OFFF 2FFF
                   0088 ERR_LP_1 GOTO
                                       ERR_LP_1
                                                        ; If you get here your program was lost
                   0089;
                   0090;
                   0091
                           end
                   0092
                   0093
                   0094
                   0095
MEMORY USAGE MAP ('X' = Used, '-' = Unused)
0000 : XXXXXXXXX-----
0040 : -----
All other memory blocks unused.
            Ω
Errors :
Warnings :
            0
Messages :
            0
```

Note: Special Function Register data memory locations, in Bank 1, are specified by their true address in the file PIC16CXXX.INC. The use of the MPASM assembler will generate a warning message, when those labels are used with direct addressing. Warning messages can be turned off with an assembler option.

PIC17CXXX BIT TOGGLE

```
MPASM 01.02.04 Intermediate P17_B0T.ASM 12-19-1994 17:15:3
                                                             PAGE 1
LOC OBJECT CODE
               LINE SOURCE TEXT
 VALUE
                0001
                         LIST P = 17C42, F = INHX32, n = 66
                0002;
                0004;
                0005 ; This program is a minimum program to toggle a single I/O port pin for the
                0006; 17Cxx family of devices. The only initialization is that of the data
                0007 ; direction register (DDR) of the I/O pin and the Toggling of the pin.
                0008 ; The waveform will be 1 unit high and 1 unit low.
                0009:
                                      P17_B0T.ASM
                0010 ;
                         Program:
                0011;
                         Revision Date: 12-20-94
                0012;
                0014 ;
                0015 ;
                0016 ; HARDWARE SETUP
                0017 ;
                0018 ;
                0019;
                0020
                             INCLUDE <p17Cxx.inc>
                0002 ; P17CXX.INC Standard Header File, Version 0.2 Microchip Technology, Inc.
                0020
                0021 ;
 FFE2
                0022
                          __FUSES ( _MC_MODE & _WDT_NORM & _XT_OSC )
                0023;
                0025 ;****
                            Start program here.
                0026 ;*********
                                 0027 ;
0000
                0028 START
                                               ; POWER_ON Reset (Beginning of program)
0000 2904
                                               ; Do initialization
                0029
                             CLRF
                                   ALUSTA
0001 290F
                0030
                             CLRF
                                   BSR
                                               ; Bank 0
0002 B000
                             MOVLW
                0031
                                   0 \times 0.0
                                               ; Specify value for PortB output latch
0003 0112
                0032
                             MOVWF
                                   PORTB
0004 B000
                0033
                            MOVLW
                                   0x00
                                               ; Specify which PortB pins are inputs / outputs
0005 0111
                0034
                             MOVWF
                                  DDRB
                0035;
0006 3812
                            BTG
                                   PORTB, 0
                                               ; Toggle level on B0
                0036 lzz
0007 C006
                0037
                             GOTO
                                  lzz
                                               ; Loop
                0038;
                0039 ;
                0040
                0041 ;
                0042 ; End of Program Memory
                0043 ;
                             __17C42
                0044
                       IFDEF
 07FF
                0045 PROG_MEM_END
                                      0x7FF
                              EQU
                0046
                      ENDIF
                0047 ;
                0048;
                0049
                              PROG_MEM_END
                                               ; End of Program Memory
                         org
07FF C7FF
                0050 ERR_LP_1
                           GOTO ERR_LP_1
                                               ; If you get here your program was lost
                0051;
                0052;
                0053
                      end
                0054
                0055
MEMORY USAGE MAP ('X' = Used, '-' = Unused)
0000 : XXXXXXX------
0040 : -----
0780 : -----
All other memory blocks unused.
Errors :
          0
Warnings :
          Ω
Messages :
          0
```

WDT RESET WITH RAM VERIFY

```
BO_RAMT.ASM 6-30-1995 16:04:36
MPASM 01.20 Released
                                                                PAGE 1
LOC OBJECT CODE
                  LINE SOURCE TEXT
 VALUE
                  00001
                                     P = 17C44, F = INHX32, n = 66
                              LIST
                  00002;
                  00004;
                  00005 ; This program is a minimum program to recover from a brown-out condition thru
                  00006; the use of the WDT. The method is to load RAM locations with a known value
                  00007; and compare these locations after any RESET. If the RAM location matches the
                  00008; expected value then program flow can continue. The longer this RAM string
                  00009; is, the greater the probability that the RAM would NOT power up in that state.
                  00010 ;
                  00011 ;
                  00012 ; NOTE: This does not Guarantee device recovery, due to the random start-up
                  00013;
                              point after brown-out. This point could be a loop with a CLRWDT
                  00014 ;
                              instruction. The recommended solution is to always use a brown-out
                  00015 ;
                              circuit.
                  00016 ;
                  00017 ;
                                             B0_RAMT.ASM
                  00018 ;
                              Revision Date: 06-29-95
                  00021;
                  00022 ;
                  00023 ; HARDWARE SETUP
                  00024 ;
                              None
                  00025 ;
                  00026;
                  00027 TRUE
 0001
                                 EQU
                  00028 FALSE
 0000
                                        0
                                 EOU
                  00029 ;
 0001
                  00030 Debug
                                 EOU
                                        TRUE
                                 __CONFIG __FUSES
                  00031 #define
                  00032;
                  00033
                                 INCLUDE <DEV_FAM.inc>
                  00102
                          list
                  00034 ;
                  00035
                          if ( P16C5X )
                  00036
                                 INCLUDE <p16C5x.inc>
                               _CONFIG ( _CP_OFF & _WDT_ON & _XT_OSC )
                  00037
                          endif
                  00038
                  00039;
                  00040
                           if ( P16CXX )
                  00041
                                 INCLUDE <pl6Cxx.inc>
                  00042
                               _CONFIG ( _CP_OFF & _WDT_ON & _XT_OSC & _PWRTE_ON )
                          endif
                  00043
                  00044 ;
                  00045
                           if ( P17CXX )
                  00046
                                 INCLUDE <p17Cxx.inc>
                             LIST
                  00001
                  00002 ;
                         P17CXX.INC Standard Header File, Version 2.01
                                                                     Microchip Technology, Inc.
                  00298
FE00 FFE2
                  00047
                              __CONFIG ( _MC_MODE & _WDT_NORM & _XT_OSC )
                  00048
                          \verb"endif"
                  00049 ;
                  00050
                           if ( P16C5X + P16CXX + P17CXX != 1 )
                  00051 MESSG "WARNING - USER DEFINED: One and only one device family can be selected"
                          endif
                  00052
                  00053;
                  00054
                                 INCLUDE <BO_RAMT.inc>
                  00029
                          list
                  00055
                                 INCLUDE <PMEM END.inc>
                  00116
                          list
                  00056;
                  00057;
                  00059 ;****
                                Start program here.
                  00060 ;*******
                  00061;
0000
                  00062
                           org Reset_Address
                  00063 ;
                                                 ; in the LIST directive
                  00064
                           if ( P16C5X )
                  00065
                           org Oh
                                                 ; Override the start of this code.
                  00066
                              CLRF
                                    STATUS
                                                 ; Force program memory to Page 0
                  00067
                              CLRF
                                    FSR
                                                 ; Force Data Memory to Bank {\tt 0}
                  00068
                           endif
```

```
00069;
                     00070
                               if ( P16CXX )
                     00071
                                   CLRF
                                           PCLATH
                                                          ; Force program memory to Page 0
                     00072
                                   CLRF
                                           STATUS
                                                          ; Force Data Memory to Bank 0
                     00073
                               endif
                     00074 ;
                               if ( P17CXX )
                     00075
0000 2903
                     00076
                                   CLRF
                                           PCLATH, F
                                                          ; Force program memory to Page {\tt 0}
0001 290F
                     00077
                                   CLRF
                                           BSR, F
                                                          ; Force Peripheral / \mbox{GP} Data Memory to Bank 0
                     00078
                               endif
                     00079 ;
0002 C100
                     00080
                                   GOTO
                                           RAM TEST
                                                          ; At any reset,
                     00081
                                                          ; test the RAM
                     00082 ;
                     00083 ; In RAM_TEST, program execution is held-off until a valid "warm" reset
                     00084 ; occurs. That is, the contents of some RAM locations retain the
                     00085;
                             values that were written to them. The probability that the RAM would power-up
                     00086 ; in that state is dependent on the number of bytes of RAM used. The
                     00087 ; more RAM, the less the probability (probability = 1 / ( 2 ** 8(N+1) ).
                     00088;
                     00089;
0100
                     00090
                               org MAIN
                                                          ; In Program Memory Page 0
0100
                     00091 RAM_TEST
0100 B0A5
                     00092
                                   MOVLW BYTE_0
0101 0520
                     00093
                                   SUBWF
                                           RAMO, F
                                                          ; Result = 0?
0102 9204
                     00094
                                    BTFSS
                                           STATUS, Z
                                                          ; NO, Load Ram
0103 C110
                     00095
                                   GOTO
                                           LD_RAM
                     00096;
0104 B00F
                     00097
                                   MOVLW
                                           BYTE_1
                                                          ; YES, Check next
0105 0521
                     00098
                                    SUBWF
                                           RAM1, F
                                                          ; location
0106 9204
                     00099
                                   BTFSS
                                           STATUS, Z
                                                          ; Result = 0?
0107 C110
                     00100
                                   GOTO
                                           LD_RAM
                                                          ; NO, Load RAM
                     00101 ;
                     00102 ;
                                                          ; YES. Do Again
                     00103 ;
                     00104;
                                           BYTE_n
0108 B05A
                     00105
                                   MOVIJW
                                                          ; YES, Check nth
                                           RAMn, F
0109 0522
                                                             location
                     00106
                                    SUBWF
010A 9204
                                           STATUS, Z
                                                          i \text{ Result} = 0?
                     00107
                                   BTFSS
                     00108
                                           LD_RAM
010B C110
                                   GOTO
                                                          ; NO, Load RAM
                     00109 ;
                               if ( P16C5X || P16CXX )
                     00110
                     00111
                                    CLRF
                                           RAM0
                                                          ; YES, Time-out
                     00112
                                    CLRF
                                           RAM1
                                                              occured, clear
                     00113 ;
                                                              RAM locations
                     00114 ;
                     00115
                                   CLRF
                                           RAMn
                               endif
                     00116
                     00117 ;
                     00118 ;
                     00119
                               if ( P17CXX )
                                                          ; YES, Time-out
010C 2920
                     00120
                                    CLRF
                                           RAMO, F
010D 2921
                     00121
                                   CLRF
                                           RAM1, F
                                                              occurred, clear
                     00122 ;
                                                              RAM locations
                     00123 ;
010E 2922
                     00124
                                    CLRF
                                           RAMn, F
                     00125
                               endif
                     00126;
010F C117
                     00127
                                   GOTO
                                                          ; Initialize Device
                                           Time_Out
                     00128
0110
                     00129 LD_RAM
0110 B0A5
                                           BYTE_0
                     00130
                                    MOVLW
                                                          ; Load RAM
0111 0120
                     00131
                                    MOVWF
                                           RAM0
                                                              locations to
0112 B00F
                     00132
                                    MOVLW
                                           BYTE_1
                                                              compare against
0113 0121
                     00133
                                   MOVWF
                                           RAM1
                     00134 ;
0114 B05A
                     00135
                                   MOVLW
                                           BYTE n
0115 0122
                     00136
                                   MOVWF
                                           RAMn
                     00137 ;
0116 C116
                     00138 HERE
                                   GOTO
                                           HERE
                                                          ; Wait for WDT TO
                     00139 Time Out
                                                          ; YES, Good Reset
0117
0117 0004
                                   CLRWDT
                     00140
                                                           Start here
                     00141 ;
                                                          ; Initialze Device
                     00142 ;
                                                          ; Application Code
                     00143 ;
                     00144
                               if ( Debug )
                                    if ( P16C5X )
                     00145
                     00146
                                        CLRF
                                                PORTB
                                                          ; PORTB output latch is cleared
                     00147
                                        MOVLW
                                                0x00
                     00148
                                       TRIS
                                                PORTB
                                                          ; Port B is output
                     00149
                                       BCF
                                                PORTB, 0 ;
                     00150
                                       BSF
                                                PORTB, 0 ; Toggle pin B0
                     00151
                                    endif
```

```
00152 ;
                    00153
                                  if ( P16CXX )
                                                           ; PORTB output latch is cleared
                    00154
                                      CLRF
                                              PORTB
                    00155
                                              STATUS, RPO ; Bank 1
                                      BSF
                                                           ; Port B is output
                    00156
                                      CLRF
                                              TRISB
                                              STATUS, RPO
                    00157
                                      BCF
                                                           ; Bank 0
                                              PORTB, 0
                    00158
                                      BCF
                    00159
                                     BSF
                                                           ; Toggle pin B0
                                  endif
                    00160
                    00161;
                                  if ( P17CXX )
                    00162
0118 2912
                    00163
                                      CLRF
                                              PORTB, F
                                                           ; PORTB output latch is cleared
                                              DDRB, F
0119 2911
                                                           ; Port B is output
                    00164
                                      CLRF
011A 8812
                    00165
                                      BCF
                                              PORTB, 0
011B 8012
                    00166
                                     BSF
                                              PORTB, 0
                                                           ; Toggle pin B0
                    00167
                                  endif
                              endif
                    00168
                    00169 ;
011C C117
                    00170
                                  GOTO
                                        Time_Out
                                                           ; Return to start of Program
                    00171 ;
                    00172
1FFF
                                  org
                                          PROG_MEM_END
                                                           ; End of Program Memory
1FFF
                    00173 ERR_LP_1
1FFF DFFF
                    00174
                                  GOTO
                                          ERR_LP_1
                                                           ; If you get here your program was lost
                    00175 ;
                    00176
                              if ( P16C5X )
                    00177
                                  NOP
                                                           ; This will cause the Program memory rollover
                    00178
                                                           ; for PIC16C5x devices
                    00179
                              endif
                    00180 ;
                    00181 ;
                    00182
                              end
```

MEMORY USAGE MAP ('X' = Used, '-' = Unused)

All other memory blocks unused.

 $\begin{array}{cccc} {\tt Errors} & : & & 0 \\ {\tt Warnings} & : & & 0 \\ {\tt Messages} & : & & 0 \\ \end{array}$

Note the following details of the code protection feature on PICmicro® MCUs.

- The PICmicro family meets the specifications contained in the Microchip Data Sheet.
- Microchip believes that its family of PICmicro microcontrollers is one of the most secure products of its kind on the market today, when used in the intended manner and under normal conditions.
- There are dishonest and possibly illegal methods used to breach the code protection feature. All of these methods, to our knowledge, require using the PICmicro microcontroller in a manner outside the operating specifications contained in the data sheet. The person doing so may be engaged in theft of intellectual property.
- · Microchip is willing to work with the customer who is concerned about the integrity of their code.
- Neither Microchip nor any other semiconductor manufacturer can guarantee the security of their code. Code protection does not mean that we are guaranteeing the product as "unbreakable".
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